

IN THE SPECIFICATION:

Please replace paragraph [0024] with the following amended paragraph:

[0024] Data from the tray map file is retrieved in step 30. As stated above, the tray map file preferably includes the results, or device parameters, of in-tray testing. The device in the current cell is marked with the tray map data in step 40. Various laser marking methods are known in the art. The methods of efficiently laser marking singulated semiconductor devices as described in United States Patents 5,986,235 and 5,937,270, and assigned to the assignee of the presently claimed invention, are incorporated herein by this reference. Further, United States ~~patent application Serial No. 09/217,040, filed December 21, 1998~~ Patent No. 6,417,484, assigned to the assignee of the present invention and hereby incorporated herein by this reference, discloses a laser marking system for dice carried in trays and method of operation.